BCM857BV; BCM857BS; BCM857DS

PNP/PNP matched double transistors

Rev. 06 — 28 August 2009

Product data sheet

1. Product profile

1.1 General description

PNP/PNP matched double transistors in small Surface-Mounted Device (SMD) plastic packages. The transistors are fully isolated internally.

Table 1. Product overview

Type number	Package		NPN/NPN	Matched version of
	Nexperia	JEITA	complement	
BCM857BV	SOT666	-	BCM847BV	BC857BV
BCM857BS	SOT363	SC-88	BCM847BS	BC857BS
BCM857DS	SOT457	SC-74	BCM847DS	-

1.2 Features

- Current gain matching
- Base-emitter voltage matching
- Drop-in replacement for standard double transistors

1.3 Applications

- Current mirror
- Differential amplifier

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	tor					
V_{CEO}	collector-emitter voltage	open base	-	-	-45	V
I _C	collector current		-	-	-100	mA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V};$ $I_{C} = -2 \text{ mA}$	200	290	450	



Table 2. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device						
h _{FE1} /h _{FE2}	h _{FE} matching	$V_{CE} = -5 \text{ V};$ $I_{C} = -2 \text{ mA}$	[1] 0.9	1	-	
V _{BE1} -V _{BE2}	V _{BE} matching	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	[2] _	-	2	mV

- [1] The smaller of the two values is taken as the numerator.
- [2] The smaller of the two values is subtracted from the larger value.

2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Symbol
1	emitter TR1		
2	base TR1	6 5 4	6 5 4
3	collector TR2		TR2
4	emitter TR2		(TR1)
5	base TR2		
6	collector TR1	001aab555	1 2 3
			sym018

3. Ordering information

Table 4. Ordering information

Type number	Package						
	Name	Description	Version				
BCM857BV	-	plastic surface-mounted package; 6 leads	SOT666				
BCM857BS	SC-88	plastic surface-mounted package; 6 leads	SOT363				
BCM857DS	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457				

4. Marking

Table 5. Marking codes

Type number	Marking code[1]
BCM857BV	3B
BCM857BS	A9*
BCM857DS	R8

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor				
V_{CBO}	collector-base voltage	open emitter	-	-50	V
V_{CEO}	collector-emitter voltage	open base	-	-45	V
V_{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current		-	-100	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	-200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$			
	SOT666		[1][2]	200	mW
	SOT363		<u>[1]</u> _	200	mW
	SOT457		<u>[1]</u> _	250	mW
Per device)				
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$			
	SOT666		[1][2] -	300	mW
	SOT363		<u>[1]</u> -	300	mW
	SOT457		<u>[1]</u> -	380	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
Per transistor								
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air						
	SOT666		[1][2]	-	625	K/W		
	SOT363		<u>[1]</u> -	-	625	K/W		
	SOT457		<u>[1]</u> _	-	500	K/W		

^[2] Reflow soldering is the only recommended soldering method.

 Table 7.
 Thermal characteristics ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per devic	e					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	SOT666		[1][2]	-	416	K/W
	SOT363		<u>[1]</u> _	-	416	K/W
	SOT457		<u>[1]</u> _	-	328	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Reflow soldering is the only recommended soldering method.

7. Characteristics

Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transist	or					
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V};$ $I_E = 0 \text{ A}$	-	-	–15	nA
		$V_{CB} = -30 \text{ V};$ $I_{E} = 0 \text{ A};$ $T_{j} = 150 \text{ °C}$	-	-	- 5	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V};$ $I_{C} = 0 \text{ A}$	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -5 \text{ V};$ $I_{C} = -10 \mu\text{A}$	-	250	-	
		$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	200	290	450	
0=001	collector-emitter saturation voltage	$I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$	-	-50	-200	mV
		$I_C = -100 \text{ mA};$ $I_B = -5 \text{ mA}$	-	-200	-400	mV
V _{BEsat} base-emitter saturation voltage		$I_C = -10 \text{ mA};$ $I_B = -0.5 \text{ mA}$	<u>[1]</u> _	-760	-	mV
		$I_C = -100 \text{ mA};$ $I_B = -5 \text{ mA}$	<u>[1]</u> _	-920	-	mV
V_{BE}	base-emitter voltage	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	<u>[2]</u> –600	-650	-700	mV
		$V_{CE} = -5 \text{ V};$ $I_{C} = -10 \text{ mA}$	[2] -	-	-760	mV
C _c	collector capacitance	$V_{CB} = -10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	-	2.2	pF
C _e	emitter capacitance	$V_{EB} = -0.5 \text{ V};$ $I_{C} = i_{c} = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	10	-	pF

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Table 8. Characteristics ...continued $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _T	transition frequency	$V_{CE} = -5 \text{ V};$ $I_{C} = -10 \text{ mA};$ $f = 100 \text{ MHz}$	100	175	-	MHz
NF noise figure	noise figure	$V_{CE} = -5 \text{ V};$ $I_{C} = -0.2 \text{ mA};$ $R_{S} = 2 \text{ k}\Omega;$ $f = 10 \text{ Hz to}$ 15.7 kHz	-	1.6	-	dB
		$V_{CE} = -5 \text{ V};$ $I_{C} = -0.2 \text{ mA};$ $R_{S} = 2 \text{ k}\Omega;$ $f = 1 \text{ kHz};$ $B = 200 \text{ Hz}$	-	3.1	-	dB
Per device						
h _{FE1} /h _{FE2}	h _{FE} matching	$V_{CE} = -5 \text{ V};$ $I_C = -2 \text{ mA}$	[3] 0.9	1	-	
$V_{BE1}-V_{BE2}$	V _{BE} matching	$V_{CE} = -5 \text{ V};$ $I_{C} = -2 \text{ mA}$	<u>[4]</u> _	-	2	mV

^[1] V_{BEsat} decreases by about 1.7 mV/K with increasing temperature.

^[3] The smaller of the two values is taken as the numerator.

^[4] The smaller of the two values is subtracted from the larger value.

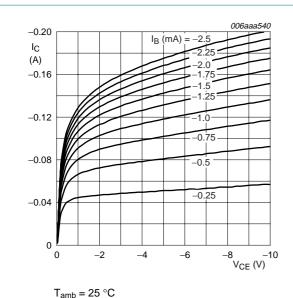
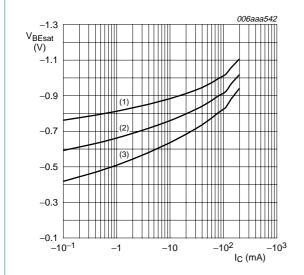


Fig 1. Collector current as a function of collector-emitter voltage; typical values



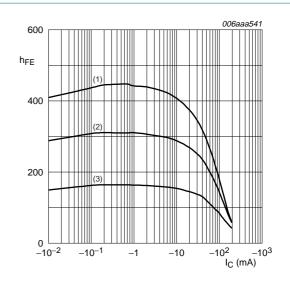
 $I_{\rm C}/I_{\rm B} = 20$

(1) $T_{amb} = -55 \,^{\circ}C$

(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = 100 \, ^{\circ}C$

Fig 3. Base-emitter saturation voltage as a function of collector current; typical values



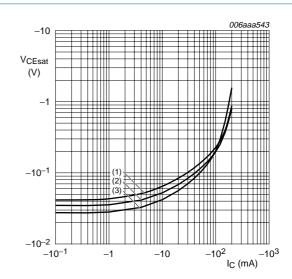
 $V_{CE} = -5 \text{ V}$

(1) $T_{amb} = 100 \, ^{\circ}C$

(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = -55 \, ^{\circ}C$

Fig 2. DC current gain as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$

(1) $T_{amb} = 100 \, ^{\circ}C$

(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = -55 \, ^{\circ}C$

Fig 4. Collector-emitter saturation voltage as a function of collector current; typical values

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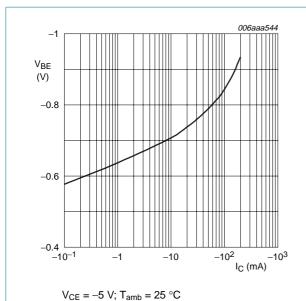
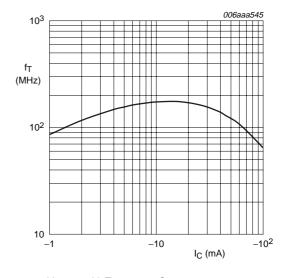


Fig 5. Base-emitter voltage as a function of collector current; typical values



 $V_{CE} = -5 \text{ V}; T_{amb} = 25 \,^{\circ}\text{C}$

Fig 6. Transition frequency as a function of collector current; typical values

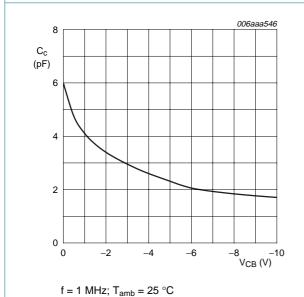
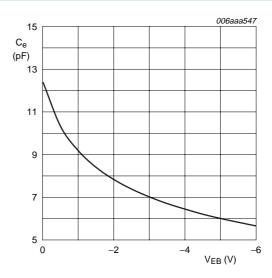


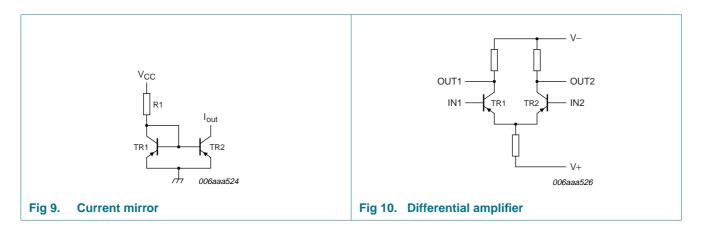
Fig 7. Collector capacitance as a function of collector-base voltage; typical values



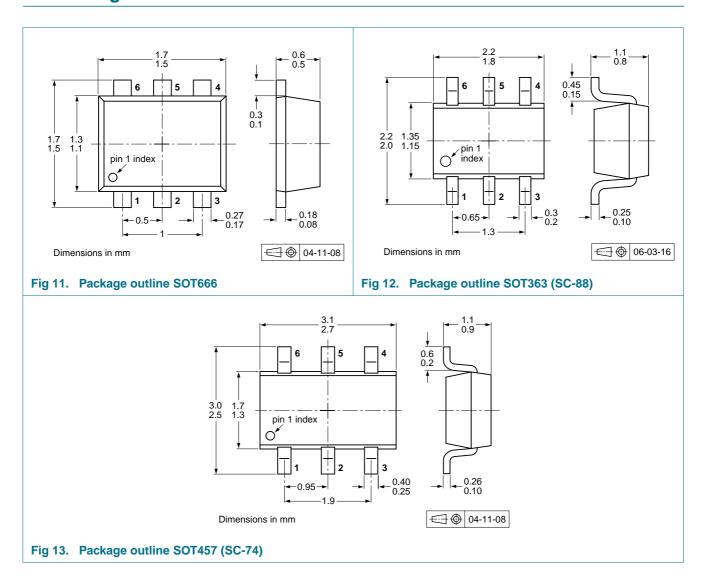
 $f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$

Fig 8. Emitter capacitance as a function of emitter-base voltage; typical values

8. Application information



9. Package outline

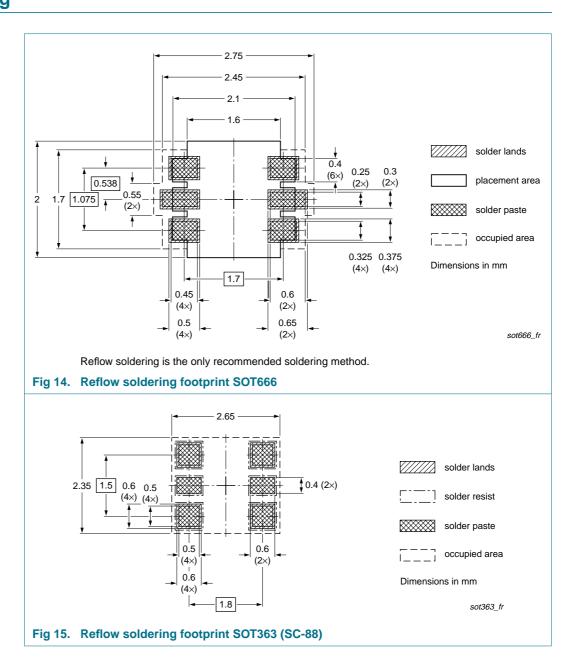


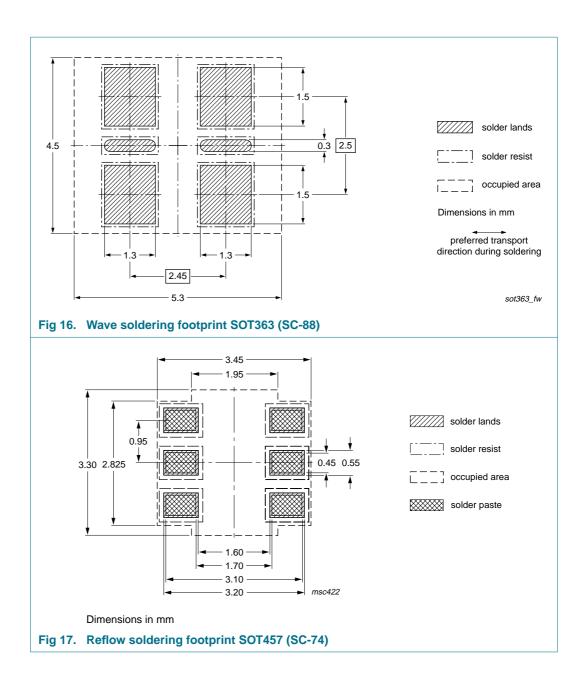


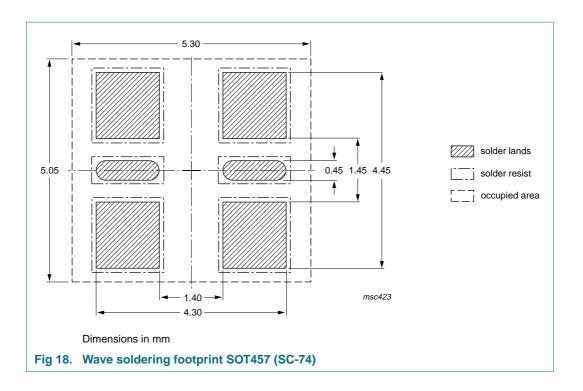
10. Packing information

Please refer to packing information on www.nexperia.com.

11. Soldering







12. Revision history

Table 10. Revision history

Release date	Data sheet status	Change notice	Supersedes	
20090828	Product data sheet	-	BCM857BV_BS_DS_5	
	1 7	,		
 Figure 12 "Package outline SOT363 (SC-88)": updated 				
Figure 14 "F	Reflow soldering footprint S	SOT666": updated		
 Figure 15 "F 	Reflow soldering footprint S	SOT363 (SC-88)": updat	ed	
• Figure 16 "\	Nave soldering footprint SC	OT363 (SC-88)": update	d	
• Figure 18 "\	Nave soldering footprint So	OT457 (SC-74)": update	d	
20060627	Product data sheet	-	BCM857BS_DS_4	
20060216	Product data sheet	-	BCM857BS_DS_3	
20060130	Product data sheet	-	BCM857BS_2	
20050411	Product data sheet	-	BCM857BS_1	
	Product data sheet			
	20090828 This data slincluding ne content. Figure 12 "Figure 14 "Figure 15 "Figure 16 "No Figure 18 "No 20060627 20060627 20060216 20060130	 This data sheet was changed to reflect including new legal definitions and discontent. Figure 12 "Package outline SOT363 (State of the state of the	 This data sheet was changed to reflect the new company namincluding new legal definitions and disclaimers. No changes we content. Figure 12 "Package outline SOT363 (SC-88)": updated Figure 14 "Reflow soldering footprint SOT666": updated Figure 15 "Reflow soldering footprint SOT363 (SC-88)": updated Figure 16 "Wave soldering footprint SOT363 (SC-88)": update Figure 18 "Wave soldering footprint SOT363 (SC-88)": update Figure 18 "Wave soldering footprint SOT457 (SC-74)": update 20060627 Product data sheet - 20060216 Product data sheet - 20060130 Product data sheet - 	

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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BCM857BV/BS/DS

PNP/PNP matched double transistors

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